Dual N-channel MOSFET Copper plating pads

KFCAB12058NL **Datasheet**

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1. GENERAL DESCRIPTION

Gate resistor installed Dual N-channel MOSFET for lithium-ion secondary battery protection circuits.

2. FEATURES

- Source-source On-state Resistance: RSS(on) typ = $4.3 \text{ m}\Omega$ (VGS = 3.8 V)
- · CSP (Chip Size Package)
- · Copper plating pads for embedded board
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL: Level 1)

3. MARKING SYMBOL: KD

4. PACKAGING

Embossed type (Thermo-compression sealing): 10,000 pcs / reel (standard)

5. ABSOLUTE MAXIMUM RATINGS Ta = 25 °C

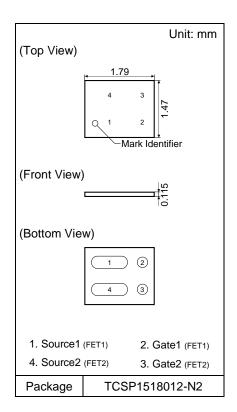
Parameter		Symbol	Rating	Unit	
Source-source Voltage		VSS	12	V	
Gate-source Voltage		VGS	± 8	V	
	DC *1	IS1	9.3		
Course Current	DC *2	IS2	15.8	Δ	
Source Current	DC *3	IS3	21.1	А	
	Pulsed*4	ISp	93		
	DC *1	PD1	0.49		
Total Power Dissipation	DC *2	PD2	1.40	W	
	DC *3	PD3	2.50		
Operating Junction and Storage Temperature Range		Tj, Tstg	- 55 to + 150	°C	

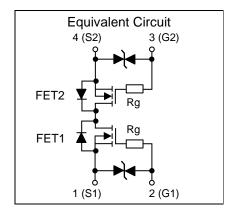
6. THERMAL CHARACTERISTICS Ta = 25 °C

Parameter	Symbol	Rating	Unit
	Rth1 *1	255	
Thermal Resistance (ch-a)	Rth2 *2	89	°C / W
	Rth3*3	50	

Note *1 Mounted on FR4 board (25.4 mm x 25.4 mm x t1.0 mm). FR4 board partially covered with copper pad (23 mm² area, 36 µm thickness).

- *2 Mounted on FR4 board (25.4 mm x 25.4 mm x t1.0 mm). FR4 board fully covered with copper pad (604 mm² area, 36 μm thickness).
- *3 Mounted on ceramic board (70 mm x 70 mm x t1.0 mm).
- *4 $t = 10 \mu s$, Duty Cycle $\leq 1 \%$.





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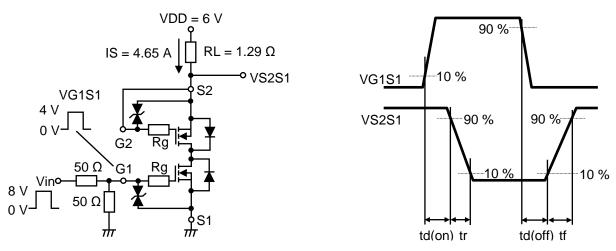
7. ELECTRICAL CHARACTERISTICS Ta = 25 °C ± 3 °C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit	
Source-source Breakdown Voltage	VSSS	IS = 1 mA, VGS = 0 V	12			V	
Zero Gate Voltage Source Current	ISSS	VSS = 12 V, VGS = 0 V			1	μΑ	
Cata course Lankage Current	IGSS1	VGS = ± 8 V, VSS = 0 V			± 5	μΑ	
Gate-source Leakage Current	IGSS2	VGS = ± 5 V, VSS = 0 V			± 0.5	μΑ	
Gate-source Threshold Voltage	Vth	IS = 0.50 mA, VSS = 6 V	0.35	0.90	1.40	V	
	RSS(on)1	IS = 4.65 A, VGS = 4.5 V	2.8	4.1	5.4		
Source course On state Resistance	RSS(on)2	IS = 4.65 A, VGS = 3.8 V	2.9	4.3	5.6		
Source-source On-state Resistance	RSS(on)3	IS = 4.65 A, VGS = 3.1 V	3.0	4.7	6.9	mΩ	
	RSS(on)4	IS = 4.65 A, VGS = 2.5 V	3.3	5.6	10.7		
Body Diode Forward Voltage	VF(s-s)	IF = 4.65 A, VGS = 0 V		0.7	1.0	V	
Input Capacitance *1	Ciss			3500			
Output Capacitance *1	Coss	VSS = 10 V, VGS = 0 V, f = 1 kHz		520		pF	
Reverse Transfer Capacitance *1	Crss			450			
Turn-on Delay Time *1, *2	td(on)	VDD = 6 V, VGS = 0 to 4 V		1.1			
Rise Time *1, *2	tr	IS = 4.65 A		1.9		μs	
Turn-off Delay Time *1, *2	td(off)	VDD = 6 V, VGS = 4 to 0 V		4.8			
Fall Time *1, *2	tf	IS = 4.65 A		3.0		μs	
Total Gate Charge *1	Qg	VDD = 6 V		29			
Gate-source Charge *1	Qgs	VGS = 0 to 4 V		7.9		nC	
Gate-drain Charge *1	Qgd	IS = 9.3 A		5.4			
Gate Resistance *1	Rg	f = 1 MHz	400	700	1000	Ω	

Note Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 Measuring methods for transistors.

All electrical characteristics are measured values in the surface mount state.

- *1 Guaranteed by design, not subject to production testing.
- *2 Measurement circuit for Turn-on Delay Time / Rise Time / Turn-off Delay Time / Fall Time.

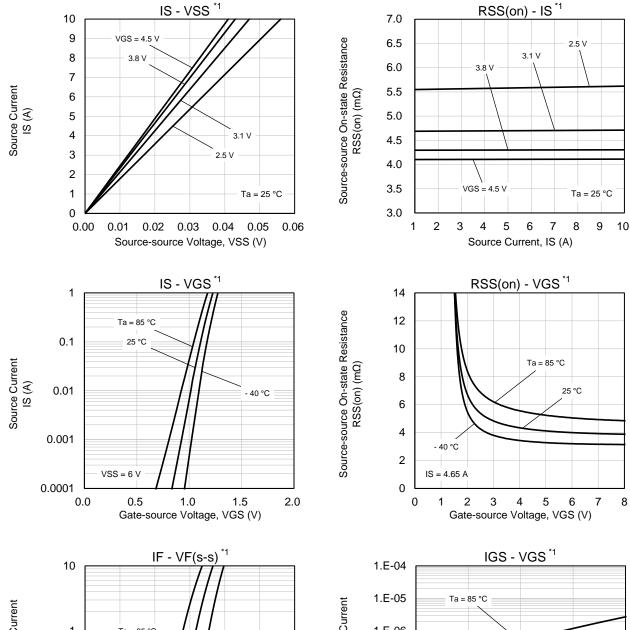


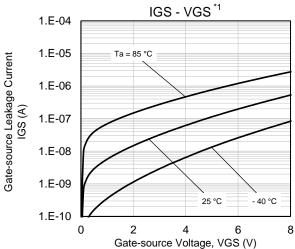
8. ELECTROSTATIC DISCHARGE CHARACTERISTIC Ta = 25 °C ± 3 °C

Standard	Test Type	Symbol	Conditions	Class	Value	Unit
AEC-Q101-001	Human Body Model	HBM	$C = 100 \text{ pF}, R = 1.5 \text{ k}\Omega$	H2	> 2k to ≤ 4k	V



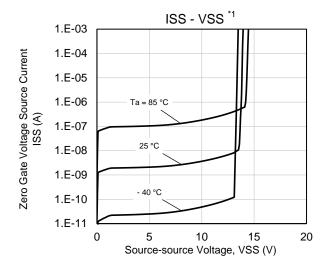
9. TECHNICAL DATA (Reference)

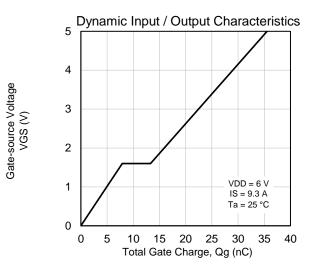


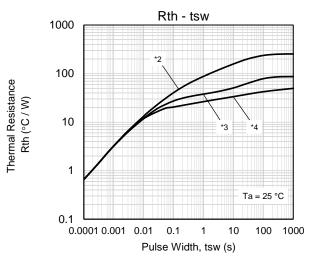


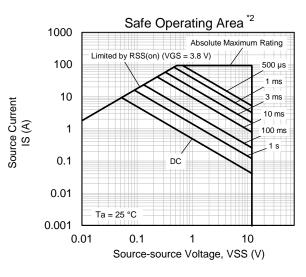
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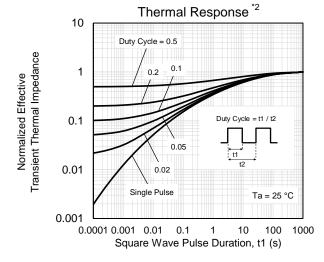
TECHNICAL DATA (Reference)











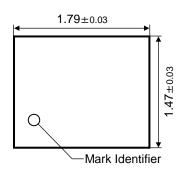
Note

Technical data are measured values in the surface mount state.

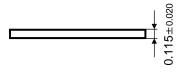
- *1 Pulse measurement.
- *2 Mounted on FR4 board (25.4 mm x 25.4 mm x t1.0 mm). FR4 board partially covered with copper pad (23 mm² area, 36 μm thickness).
- *3 Mounted on FR4 board (25.4 mm x 25.4 mm x t1.0 mm). FR4 board fully covered with copper pad (604 mm² area, 36 µm thickness).
- *4 Mounted on ceramic board (70 mm x 70 mm x t1.0 mm).

10. OUTLINE

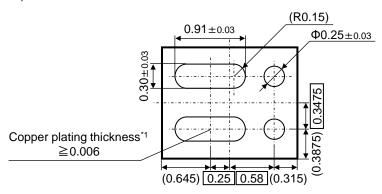
(Top View) Unit: mm



(Front View)



(Bottom View)



Note *1 Copper plating thickness guaranteed by sampling test.

11. REVISION HISTORY

Date	Revision	Description
2024.4.15	1.00	1. Initially issued.
2025.1.9	2.00	Changed special attention and precautions notes.



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ADVANCE INFORMATION



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